

Single P-channel MOSFET

ELM14423AA-N

■ General description

ELM14423AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance. Internal ESD protection is included.

■ Features

- $V_{ds} = -30V$
- $I_d = -15A$ ($V_{gs} = -20V$)
- $R_{ds(on)} < 7m\Omega$ ($V_{gs} = -20V$)
- $R_{ds(on)} < 8.5m\Omega$ ($V_{gs} = -10V$)
- ESD Rating : 6000V HBM

■ Maximum absolute ratings

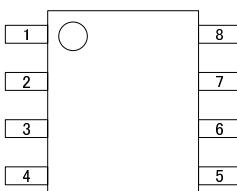
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-30	V	
Gate-source voltage	V_{gs}	± 25	V	
Continuous drain current <small>T_a=25°C</small>	I_d	-15.0	A	1
<small>T_a=70°C</small>		-12.1		
Pulsed drain current	I_{dm}	-80	A	2
Power dissipation <small>T_a=25°C</small>	P_d	3.1	W	1
<small>T_a=70°C</small>		2.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	26	40	°C/W	1
Maximum junction-to-ambient	Steady-state		50	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	14	24	°C/W	3

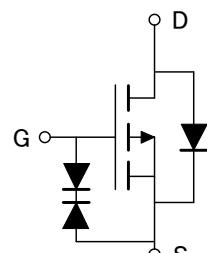
■ Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	$Id=-250\ \mu A, Vgs=0V$	-30			V
Zero gate voltage drain current	Idss	$Vds=-24V$ $Vgs=0V$			-100 -500	nA
Gate-body leakage current	Igss	$Vds=0V, Vgs=\pm 20V$ $Vds=0V, Vgs=\pm 25V$			± 1 ± 10	μA
Gate threshold voltage	Vgs(th)	$Vds=Vgs, Id=-250\ \mu A$	-2.0	-2.7	-3.5	V
On state drain current	Id(on)	$Vgs=-10V, Vds=-5V$	-80			A
Static drain-source on-resistance	Rds(on)	$Vgs=-20V$ $Id=-15A$ $T_j=125^\circ C$ $Vgs=-10V, Id=-15A$ $Vgs=-6V, Id=-10A$		5.7 7.1 6.8 9.4	7.0 8.6 8.5 12.0	$m\Omega$
Forward transconductance	Gfs	$Vds=-5V, Id=-15A$	43			S
Diode forward voltage	Vsd	$Is=-1A, Vgs=0V$		-0.71	-1.00	V
Max. body-diode continuous current	Is				-4.2	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	$Vgs=0V, Vds=-15V, f=1MHz$		4632		pF
Output capacitance	Coss			1034		pF
Reverse transfer capacitance	Crss			705		pF
Gate resistance	Rg	$Vgs=0V, Vds=0V, f=1MHz$		2.5		Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	$Vgs=-10V, Vds=-15V$ $Id=-15A$		82.0		nC
Gate-source charge	Qgs			16.8		nC
Gate-drain charge	Qgd			23.0		nC
Turn-on delay time	td(on)	$Vgs=-10V, Vds=-15V$ $Rl=1\ \Omega, Rgen=3\ \Omega$		18.5		ns
Turn-on rise time	tr			20.0		ns
Turn-off delay time	td(off)			55.0		ns
Turn-off fall time	tf			30.0		ns
Body diode reverse recovery time	trr	$If=-15A, dl/dt=100A/\mu s$		43		ns
Body diode reverse recovery charge	Qrr	$If=-15A, dl/dt=100A/\mu s$		38		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

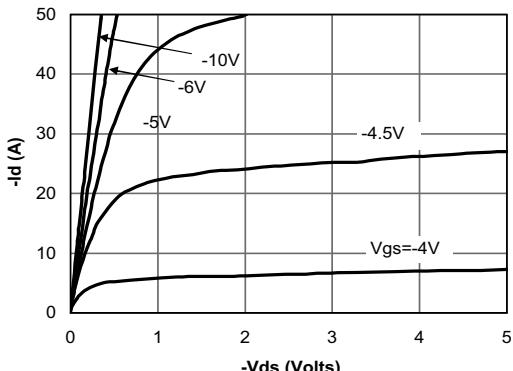


Fig 1: On-Region Characteristics

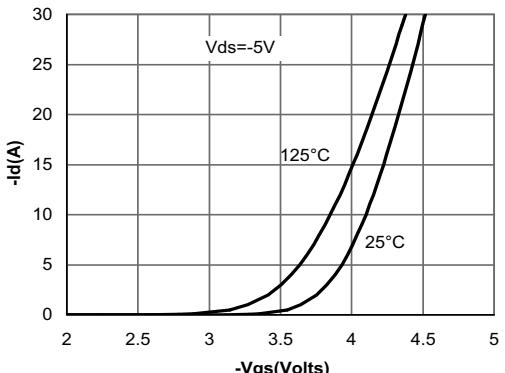


Figure 2: Transfer Characteristics

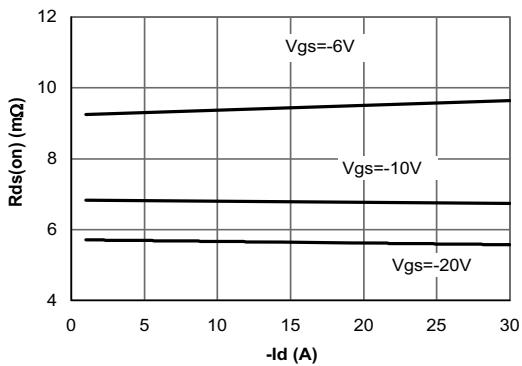


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

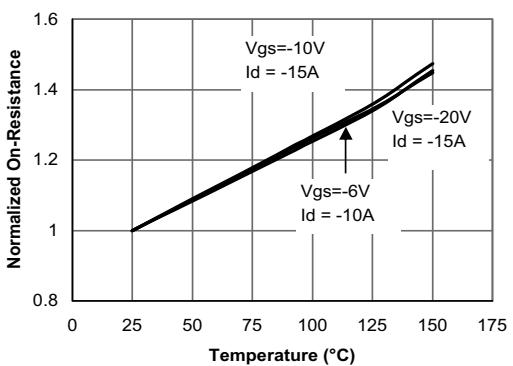


Figure 4: On-Resistance vs. Junction Temperature

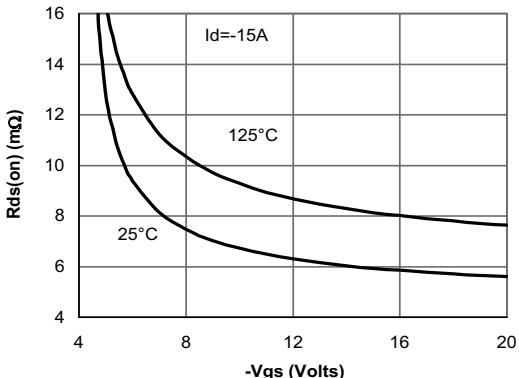


Figure 5: On-Resistance vs. Gate-Source Voltage

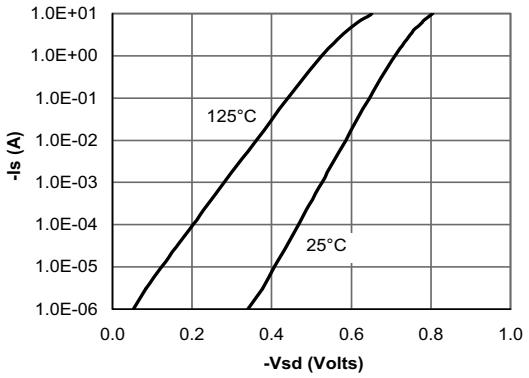


Figure 6: Body-Diode Characteristics

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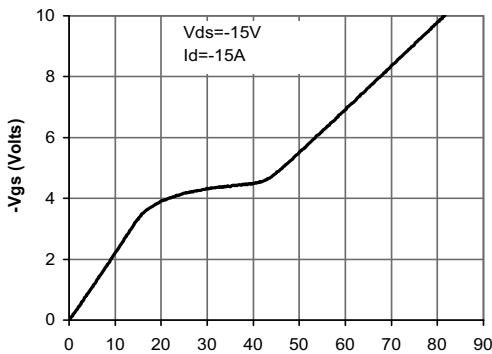


Figure 7: Gate-Charge Characteristics

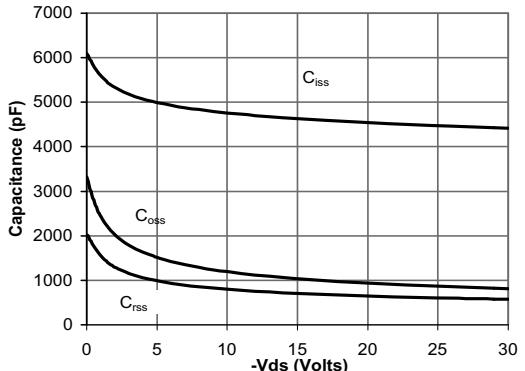


Figure 8: Capacitance Characteristics

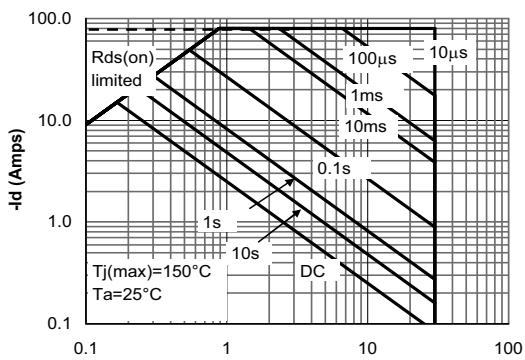


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

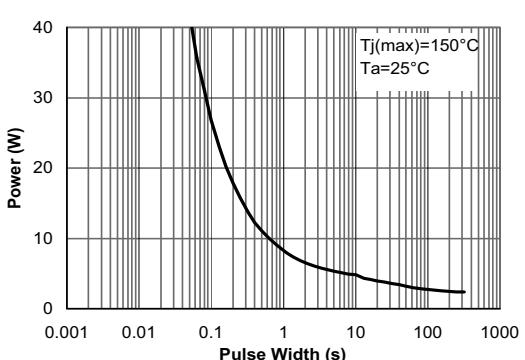


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

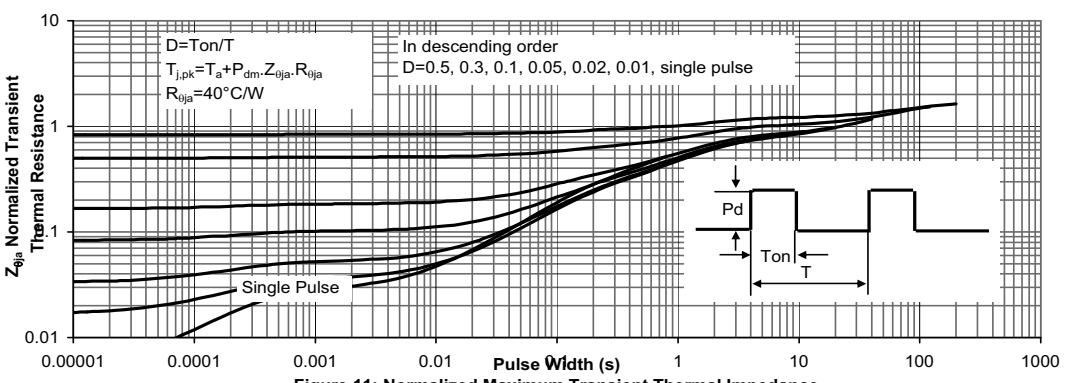


Figure 11: Normalized Maximum Transient Thermal Impedance